

# UNISONIC TECHNOLOGIES CO., LTD

3N50-LC1 Power MOSFET

# 3.0A, 500V N-CHANNEL POWER MOSFET

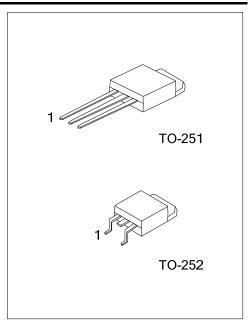
#### DESCRIPTION

The UTC **3N50-LC1** is an N-channel power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance and superior switching performance.

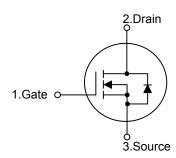
The UTC **3N50-LC1** is generally applied in low power switching mode power appliances and electronic ballast.

#### ■ FEATURES

- \*  $R_{DS(ON)} \le 3.1 \Omega @ V_{GS} = 10V, I_D = 1.5A$
- \* High Switching Speed
- \* 100% Avalanche Tested



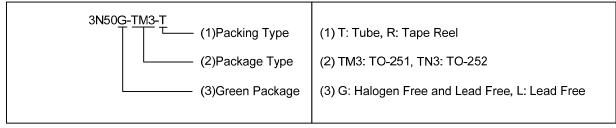
#### ■ SYMBOL



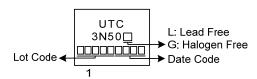
### ORDERING INFORMATION

Ordering Number		Doolsone	Pin .	Assignn	Dealing		
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N50L-TM3-T	3N50G-TM3-T	TO-251	G	D	S	Tube	
3N50L-TN3-R	3N50G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



## **■** MARKING



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3N50-LC1 Power MOSFET

## ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	500	V
Gate-Source Voltage		V <sub>GSS</sub> ±30		V
Drain Current	Continuous	I <sub>D</sub>	3	Α
	Pulsed (Note 2)	I <sub>DM</sub>	6	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	54.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.65	V/ns
Power Dissipation		P <sub>D</sub> 45		W
Junction Temperature		$T_J$	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

- Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

  Absolute maximum ratings are stress ratings only and functional device operation is not implied.
  - 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
  - 3. L = 10mH,  $I_{AS}$  = 3.3A,  $V_{DD}$  = 50V,  $R_{G}$  = 25 $\Omega$ , Starting  $T_{J}$  = 25 $^{\circ}$ C
  - 4.  $I_{SD} \le 3.0$ A, di/dt  $\le 200$ A/ $\mu$ s,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25$ °C

#### **■ THERMAL CHARACTERISTICS**

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	100	°C/W	
Junction to Case	$\theta_{JC}$	2.77 (Note)	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25°C, unless otherwise specified)

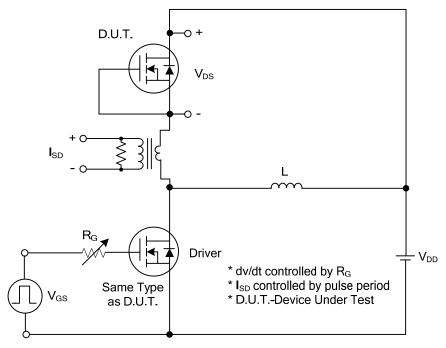
PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	$I_D = 250 \mu A, V_{GS} = 0 V$	500			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =500V, V <sub>GS</sub> =0V			10	μΑ
Gate- Source Leakage Current	rward	1	$V_{GS}$ =+30V, $V_{DS}$ =0V			+100	nΑ
Re	everse	I <sub>GSS</sub>	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$			4.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.5A			3.1	Ω
DYNAMIC PARAMETERS							
Input Capacitance	put Capacitance				261		pF
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		34		pF
Reverse Transfer Capacitance		$C_{RSS}$			3		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		$Q_G$	\\ -400\\ \\ -10\\ \ \ -2.0\\		7.3		nC
Gate to Source Charge		$Q_GS$	V <sub>DS</sub> =400V, V <sub>GS</sub> =10V, I <sub>D</sub> =3.0A		2.9		nC
Gate to Drain Charge		$Q_GD$	IG-IIIA (Note 1, 2)		1		nC
Turn-ON Delay Time (Note 1)		t <sub>D(ON)</sub>			4		ns
Rise Time		$t_R$	V <sub>DD</sub> =100V, V <sub>GS</sub> =10V,		15.5		ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	$I_D$ =3.0A, $R_G$ =25 $\Omega$ (Note 1, 2)		19.3		ns
fall-Time		$t_{F}$			22		ns
SOURCE- DRAIN DIODE RATINGS AN	D CHA	RACTERISTI	cs				
Maximum Body-Diode Continuous Current		Is				3	Α
Maximum Body-Diode Pulsed Current (Note 1)		I <sub>SM</sub>				6	Α
Drain-Source Diode Forward Voltage (Note 1)		$V_{SD}$	I <sub>S</sub> =3.0A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time		t <sub>rr</sub>	I <sub>S</sub> =3.0A, V <sub>GS</sub> =0V,		260		ns
Body Diode Reverse Recovery Charge		$Q_{rr}$	dI <sub>F</sub> /dt=100A/μs		1		μC

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

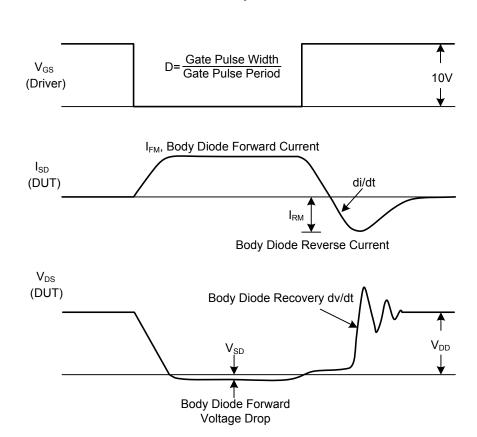
2. Essentially independent of operating temperature.

3N50-LC1

## **■ TEST CIRCUITS AND WAVEFORMS**



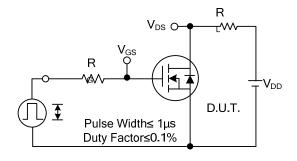
Peak Diode Recovery dv/dt Test Circuit



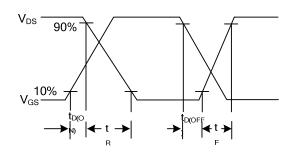
Peak Diode Recovery dv/dt Waveforms

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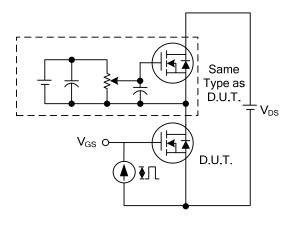
## **■ TEST CIRCUITS AND WAVEFORMS**



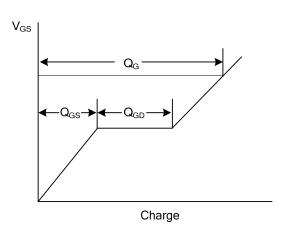
**Switching Test Circuit** 



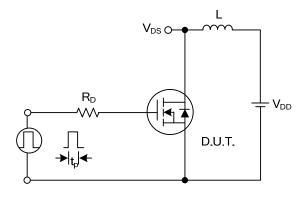
Switching Waveforms



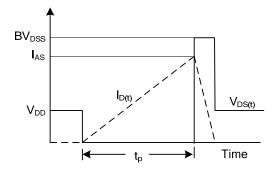
Gate Charge Test Circuit



Gate Charge Waveform

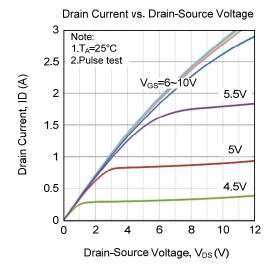


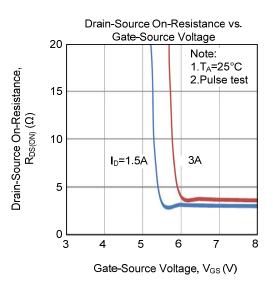
**Unclamped Inductive Switching Test Circuit** 

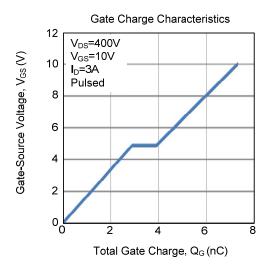


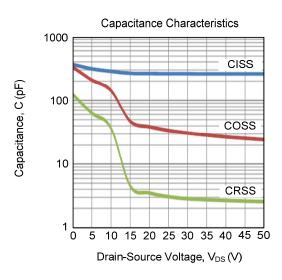
**Unclamped Inductive Switching Waveforms** 

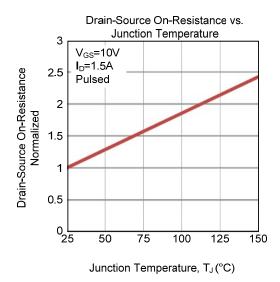
## **■ TYPICAL CHARACTERISTICS**

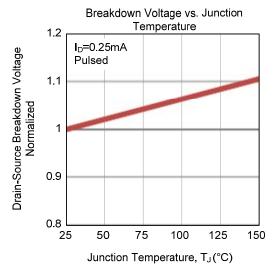




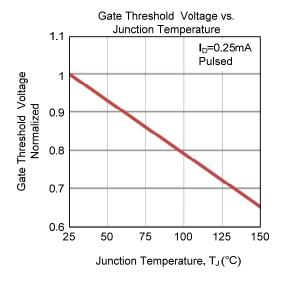


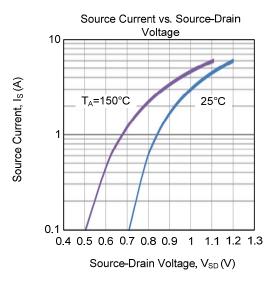


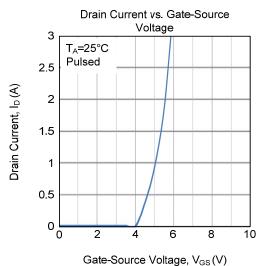


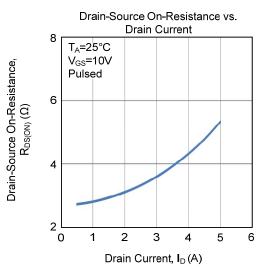


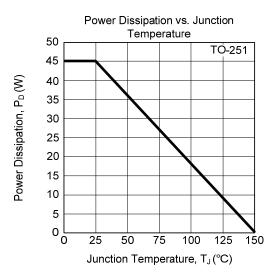
## **■ TYPICAL CHARACTERISTICS (Cont.)**

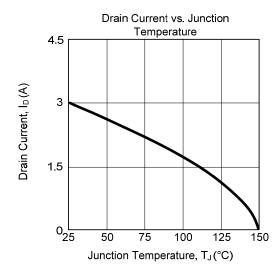




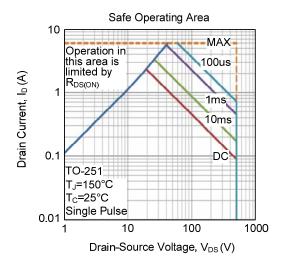








## **■ TYPICAL CHARACTERISTICS (Cont.)**



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